

12-06-2000

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Form-PTO-1595

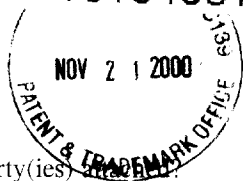
1-31-92 11.21.00

RECORDATION

Atty. Docket: 684.3061



101540810



To the Director, U.S. Pa

ie attached original documents or copy thereof

1. Name of conveying party:

Ken Matsumoto

Additional name(s) of conveying party(ies)

Yes  No

... and address of receiving party(ies):

Name: CANON KABUSHIKI KAISHA

Foreign Address: 30-2, Shimomaruko 3-chome, Ohta-ku

Tokyo, Japan

Domestic Address:

City: \_\_\_\_\_ State \_\_\_\_\_ ZIP \_\_\_\_\_

Additional name(s) & address(es) attached?  Yes  No

3. Nature of conveyance:

Assignment  Merger  
 Security Agreement  Change of Name  
 Other

Execution Date: 11/06/00

4. Application number or patent number:

If this document is being filed together with a new application, the execution date of the application is: \_\_\_\_\_

A. Patent Application Number: 09/650,992  
Filing Date: August 31, 2000

B. Title of Invention:  
SEMICONDUCTOR MANUFACTURING  
APPARATUS AND METHOD

Additional numbers attached?  Yes  No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Fitzpatrick, Cella, Harper & Scinto

30 Rockefeller Plaza

New York, New York 10112-3801

Telephone No.: (212) 218-2100

Facsimile No.: (212) 218-2200

6. Number of applications and patents involved:

One

7. Total fee (37 CFR 3.41): . . . \$ 40.00

Enclosed  
 Authorized to be charged to deposit account

8. Deposit account number (for deficiency or excess)

06-1205

(Attach duplicate copy of this page if paying by deposit account)

12/05/2000 MTHAI1 00000219 0965099E

01 FC:581 40.00 DP

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and the attached is the original document or is a true copy of the original document.

Laura A. Bauer

Name of Person Signing

Signature

November 20, 2000

Date

Total number of pages including cover sheet, attachments, and documents: 2

**Assignment**

FOR VALUE RECEIVED

**Ken MATSUMOTO**

citizen(s) of Japan

residing at (respectively)  
3-2-3-A-601 Oozo, Utsunomiya-shi, Tochigi-ken, Japan

hereby sell, assign, transfer and convey unto  
**CANON KABUSHIKI KAISHA,** a corporation of Japan having a place of business at  
3-30-2 Shimomaruko, Ohta-ku, Tokyo, Japan,

its successors, assigns and legal representatives (hereinafter called the "Assignee"), the entire right, title and interest,  
for the United States in and to certain inventions relating to

**SEMICONDUCTOR MANUFACTURING APPARATUS AND METHOD**

and described in an application for Letters Patent of the United States filed on 31/AUG/2000 as Application No. 09/650,992  
and in and to said application, and all divisions, renewals and continuations thereof, and all Letters Patent of the United  
States which may be granted thereon, and all reissues and extensions thereof; and I hereby authorize and request the  
Commissioner for Patents and Trademarks of the United States to issue all Letters Patent upon said inventions to the  
Assignee or to such nominees as it may designate.

AND I authorize and empower the said Assignee or nominees to invoke and claim for any application for patent or other  
form of protection for said inventions, the benefit of the right of priority provided by the International Convention  
for the Protection of Industrial Property, as amended, or by any convention which may henceforth be substituted for it,  
and to invoke and claim such right of priority without further written or oral authorization from me.

AND I hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any assign-  
ment, consent to file or like document which may be required in the United States for any purpose and more particularly  
in proof of the right of said Assignee or nominees to claim the aforesaid benefit of the right of priority provided by the  
International Convention for the Protection of Industrial Property, as amended, or by any convention which may hence-  
forth be substituted for it.

AND I hereby covenant that I have the full right to convey the entire right, title and interest herein assigned and  
that I have not executed and will not execute any agreement in conflict herewith.

AND I hereby covenant and agree that I will communicate to said Assignee or nominees all facts known to me pertain-  
ing to said inventions, and testify in all legal proceedings, sign all lawful papers, execute all divisional, continuing and  
reissue applications, make all rightful oaths and declarations and in general perform all lawful acts necessary or proper  
to aid said Assignee or nominees in obtaining, maintaining and enforcing all lawful patent protection for said inventions  
in the United States.

By: Ken Matsumoto  
Ken MATSUMOTO

Date: November 6, 2000

By: \_\_\_\_\_

Date: \_\_\_\_\_

By: \_\_\_\_\_

Date: \_\_\_\_\_